

标 记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修 改 REVISE	日 期 DATE	核 准 APPROVE

A

B

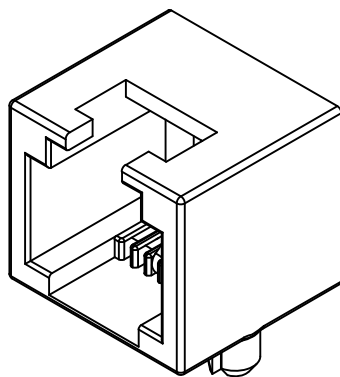
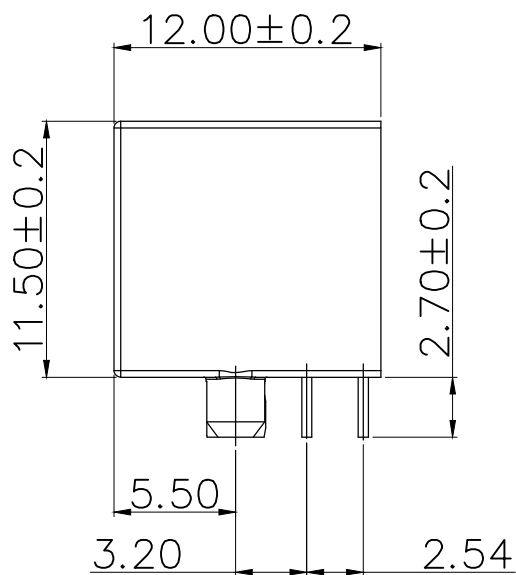
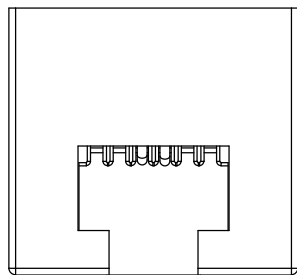
C

D

E

F

G



3D VIEW

NOTES:

1. MATERIAL:

1.1. HOUSING: PBT ,COLOR IS GRAY 537c

1.2. CONTACT: PHOSPHOR BRONZE, $\phi 0.46 \pm 0.02$ mm;

2. FINISH: PLATED GOLD OVER NI;

3. RECINNEBDED PCB THICKNESS: 1.60mm;

4. ELECTRICAL:

4.1. VOLTAGE RATING: 125 VAC RMS;

4.2. CURRENT RATING: 1.5 AMP;

4.3. CONTACT RESISTANCE: 35MILLIOHMS MAX.;

4.4. WITHSTAND VOLTAGE: 1000 VAC RMS 50(60)Hz,1MIN.;

4.5. INSULATION RESISTANCE: 1000MEGOHMS MIN @500V DC;

5. MECHANICAL:

5.1. MATING/UNMATING FORCE: 22N MAX.;

5.2. RETENTION STRENGTH: 50N MIN.;

5.3. OPERATING LIFE: 750 CYCLES MIN.;

6.SALT SPRAY TEST: 12H;

7. SOLDERABILITY: $245 \pm 5^{\circ}\text{C}$, 5 ± 0.5 S;

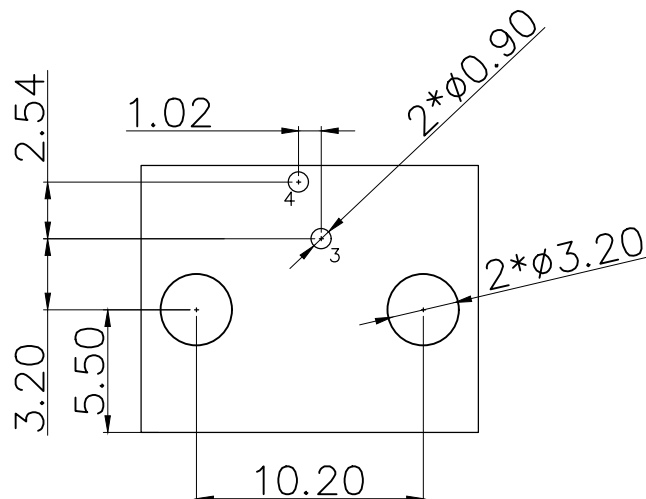
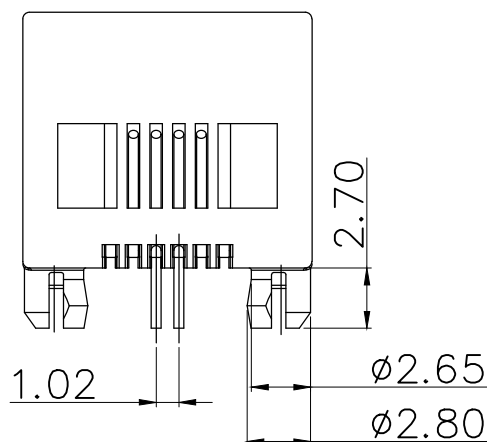
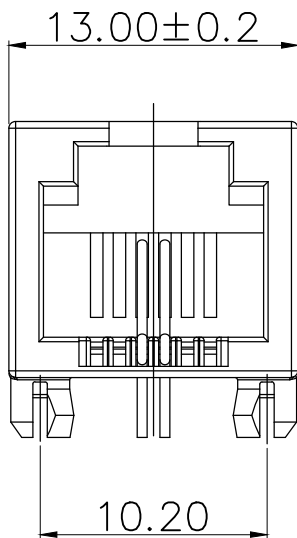
8. RESISTANCE TO SOLDER: $260 \pm 5^{\circ}\text{C}$, 10 ± 1 S;

9 ENVIRONMENTAL:

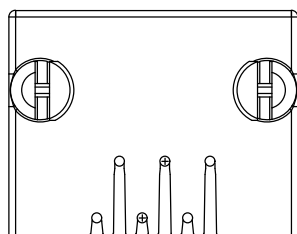
9.1. STORAGE TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$;

9.2. OPERATION TEMPERATURE RANGE: $-25^{\circ}\text{C} \sim +70^{\circ}\text{C}$;

10. MATES WITH: MODULAR PLUGS THAT CONFORM TO FCC REGULATION PART 68.500;



RECOMMENDED PCB LAYOUT
TOP VIEW (TOL: ± 0.05)



2	接触	铜	镀金G/F	
1	基座	PBT	灰白	
序 号	品 名	材 质	电镀/颜色	备 注



深圳市虹成电子有限公司

品 名 TITLE	网 口
料 号 PART NO	HC-WK62-MIH12-G

UNLESS OTHERWISE,
GENERAL TOLERANCE:

X. xxx ± 0.10
X. xx ± 0.20
X. x ± 0.30

ANGULAR:
X. xx° $\pm 1^{\circ}$
X. x° $\pm 3^{\circ}$
X. ° $\pm 5^{\circ}$

比 例
SCALE

1:1

单 位
UNIT

MM

张 数
PART NO

1 OF 1

版 本
REV

A

制 图
DRAW

AhYe

审 核
CHECKED

夏操云

批 准
APPROVE

赵亮亮

